

FAN6204 mWSaver™ Synchronous Rectification Controller for Flyback and Forward Freewheeling Rectification

Features

- mWSaver™ Technology:
	- Internal Green Mode to Stop SR Switching for Lower No-Load Power Consumption
	- 1.1 mA Ultra-Low Green Mode Operating **Current**
- SR Controller
- Suited for Flyback Converter in QR, DCM, and CCM Operation
- Suited for Forward Freewheeling Rectification
- **PWM Frequency Tracking with Secondary-Side** Winding Voltage Detection
- Ultra-Low V_{DD} Operating Voltage for Various Output Voltage Applications (5 V~24 V)
- V_{DD} Pin Over-Voltage Protection (OVP)
- 12 V (Typical) Gate Driver Clamp
- 8-Pin SOP Package

Applications

- AC/DC NB Adapters
- Open-Frame SMPS
- Battery Charger

Description

FAN6204 is a secondary-side synchronous rectification (SR) controller to drive SR MOSFET for improving efficiency. The IC is suitable for flyback converters and forward free-wheeling rectification.

FAN6204 can be applied in continuous or discontinuous conduction mode (CCM and DCM) and quasi-resonant (QR) flyback converters based on the proprietary innovative linear-predict timing-control technique. The benefits of this technique include a simple control method without current-sense circuitry to accomplish noise immunity.

With PWM frequency tracking and secondary-side winding voltage detection, FAN6204 can operate in both fixed- and variable-frequency systems.

In Green Mode, the SR controller stops all SR switching operation to reduce the operating current. Power consumption is maintained at minimum level in lightload condition.

Ordering Information

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period of the primary GATE.

8 LPC **Winding Detection**. This pin is used to detect the voltage on the winding during the on-time

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Notes:

1. Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device.
2. All voltage values, except differential voltages, are given with respect to GND pin.

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Electrical Characteristics

 V_{DD} =15 V and T_A =25°C unless otherwise noted.

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3. Guaranteed by design.

Figure 18. Typical Waveforms of Linear-Predict Timing Control in CCM and DCM/QR Flyback

Linear Predict Timing Control

The SR MOSFET turn-off timing is determined by linear-predict timing control and the operation principle is based on the volt-second balance theorem. The voltsecond balance theorem states that the inductor average voltage is zero during a switching period in steady state, so the charge voltage and charge time product is equal to the discharge voltage and discharge time product. In flyback converters, the charge voltage on the magnetizing inductor is input voltage (V_{IN}) , while the discharge voltage is nV_{OUT} , as the typical waveforms show in [Figure 18.](#page-8-0) The following equation can be drawn:

$$
V_{IN} \cdot t_{PM.ON} = n \cdot V_{OUT} \cdot t_{L.DIS}
$$
 (1)

where *tPM,ON* is inductor charge time and *tL,DIS* is inductor discharge time.

FAN6204 uses the LPC and RES pins with two sets of voltage dividers to sense DET voltage (V_{DET}) and output voltage (V_{OUT}), respectively; so V_{IN}/n , t_{PM.ON}, and V_{OUT} can be obtained. As a result, *tL,DIS* , which is the on-time of SR MOSFET, can be predicted by Equation [\(1\).](#page-8-1) As shown in [Figure 18,](#page-8-0) the SR MOSFET is turned on when the SR MOSFET body diode starts conducting and DET voltage drops to zero. The SR MOSFET is turned off by linear-predict timing control.

Circuit Realization

The linear-predict timing-control circuit generates a replica (V_{CT}) of magnetizing current of flyback transformer using internal timing capacitor (C_T) , as shown in [Figure 19.](#page-9-0) Using the internal capacitor voltage, the inductor discharge time $(t_{L,DIS})$ can be detected indirectly, as shown in [Figure 18.](#page-8-0) When C_T is discharged to zero, the SR controller turns off the SR MOSFET.

The voltage-second balance equation for the primaryside inductance of the flyback converter is given in Equation [\(1\).](#page-8-1) Inductor current discharge time is given as:

$$
t_{L,DIS} = \frac{V_{IN} \cdot t_{PM,ON}}{n \cdot V_{OUT}}\tag{2}
$$

The voltage scale-down ratio between RES and LPC is defined as K below:

$$
K = \frac{R_4 / (R_3 + R_4)}{R_2 / (R_1 + R_2)}
$$
\n(3)

During $t_{PM.ON}$, the charge current of C_T is i_{CHR} - i_{DICHR} , while during $t_{L.DIS}$, the discharge current is i_{DICHR} . As a result, the current-second balance equation for internal timing capacitor (C_T) can be derived from:

$$
(\frac{5}{K} \cdot (\frac{V_{\text{IN}}}{n} + V_{\text{OUT}}) - V_{\text{OUT}}) \cdot t_{\text{PM.ON}} = V_{\text{OUT}} \cdot t_{\text{CT.DIS}} \tag{4}
$$

Therefore, the discharge time of C_T is given as:

$$
t_{CT,DIS} = \frac{(\frac{5}{K} \cdot (\frac{V_{IN}}{n} + V_{OUT}) - V_{OUT}) \cdot t_{PM,ON}}{V_{OUT}}
$$
(5)

When the voltage scale-down ratio between RES and LPC (K) is five (5), the discharge time of C_T (t_{CT.DIS}) is the same as inductor current discharge time $(t_{\text{L},\text{DIS}})$. However, considering the tolerance of voltage divider resistors and internal circuit, the scale-down ratio (K) should be larger than five (5) to guarantee that $t_{CT.DIS}$ is shorter than $t_{\text{L,DIS}}$. It is typical to set K around 5~5.5.

Referring to [Figure 18;](#page-8-0) when LPC voltage is higher than $V_{\text{LPC-EN}}$ over a blanking time $(t_{\text{LPC-EN}})$ and lower than $V_{LPC-TH\text{-HIGH}}$ (0.05 V_{OUT}), then SR MOSFET can be triggered. Therefore, V_{LPC-EN} must be lager than V_{LPC-TH} HIGH Or the SR MOSFET cannot be turned on. When designing the voltage divider of LPC, R_1 and R_2 should be considered as:

$$
0.83 \cdot \frac{R_2}{R_1 + R_2} \cdot (\frac{V_{IN. MIN}}{n} + V_{OUT}) > 0.05V_{OUT} + 0.3
$$
 (6)

On the other hand, the linear operation range of LPC and RES (1~4 V) should be considered as:

$$
\frac{R_2}{R_1 + R_2} \cdot (\frac{V_{IN.MAX}}{n} + V_{OUT}) < 4 \tag{7}
$$

$$
\frac{R_4}{R_3 + R_4} \cdot V_{OUT} < 4\tag{8}
$$

CCM Operation

The typical waveforms of CCM operation in steady state are shown as [Figure 18.](#page-8-0) When the primary-side MOSFET is turned on, the energy is stored in L_m . During the on-time of the primary-side MOSFET (t_{PMON}) , the magnetizing current (I_M) increases linearly from $I_{M,min}$ to $I_{M,max}$. Meanwhile, internal timing capacitor (C_T) is charged by current source $(i_{CHR}-i_{DICHR})$ proportional to V_{IN} , so V_{CT} also increases linearly.

When the primary-side MOSFET is turned off, the energy stored in L_m is released to the output. During the inductor discharge time $(t_{L.DIS})$, the magnetizing current (N_M) decreases linearly from $I_{M,max}$ to $I_{M,min}$. At the same time, the internal timing capacitor (C_T) is discharged by current source (i_{DISCHR}) proportional to V_{OUT} , so V_{CT} also decreases linearly. To guarantee the proper operation of SR, it is important to turn off SR MOSFET just before SR current reaches $I_{M,min}$ so that the body diode of SR MOSFET conducts naturally during the dead time.

DCM / QR Operation

In DCM / QR operation, when primary-side MOSFET is turned off, the energy stored in L_m is fully released to the output at the turn-off timing of primary-side MOSFET. Therefore, the DET voltage continues resonating until the primary-side MOSFET is turned on, as depicted in [Figure 18.](#page-8-0) While DET voltage is resonating, DET voltage and LPC voltage drop to zero by resonance, which can trigger the turn-on of the SR MOSFET. To prevent fault triggering of the SR MOSFET in DCM operation, blanking time is introduced to LPC voltage. The SR MOSFET is not turned on even when LPC voltage drops below 0.05 V $_{\text{OUT}}$ unless LPC voltage stays above 0.83 V_{LPC-HIGH} longer than the blanking time (t_{LPC-EN}) . The turn-on timing of the SR MOFET is inhibited by gate inhibit time (t_{INHIBIT}) , once the SR MOSFET turns off, to prevent fault triggering.

mWSaver™ Technology

Green-Mode Operation

To minimize the power consumption at light-load condition, the SR circuit is disabled when the load decreases. As illustrated in [Figure 20,](#page-10-0) the discharge times of inductor and internal timing capacitor decrease as load decreases. If the discharge time of the internal timing capacitor is shorter than tGREEN-ON (around 4.8 µs) for more than three cycles, the SR circuit enters Green Mode. Once FAN6204 enters Green Mode, the SR MOSFET stops switching and the major internal block is shut down to further reduce operating current of the SR controller. In Green Mode, the operating current reduces to 1.1 mA. This allows power supplies to meet the most stringent power conservation requirements. When the discharge time of the internal capacitor is longer than $t_{\text{GREFN-OFF}}$ (around 5.35 μ s) for more than seven cycles, the SR circuit is enabled and resumes the normal operation, as shown in [Figure 21.](#page-10-1)

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Causal Function

Causal function is utilized to limit the time interval $(t_{SR}$ $_{MAX}$) from the rising edge of V_{LPC} to the falling edge of the SR gate. $t_{SR\text{-}MAX}$ is limited to 97% of previous switching period, as shown in [Figure 22.](#page-10-2) When the system operates at fixed frequency, whether voltagesecond balance theorem can be applied or not, causal function can guarantee reliable operation.

Figure 22. Causal Function Operation

Fault Causal Timing Protection

Fault causal timing protection is utilized to disable the SR gate under some abnormal conditions. Once the switching period $(t_{S-PWM}(n))$ is longer than 120% of previous switching period $(t_{S-PWM}(n-1))$, SR gate is disabled and enters Green Mode, as shown in [Figure](#page-10-3) [23.](#page-10-3) Since the rising edge of V_{LPC} among switching periods (ts-PWM) is tracked for causal function, the accuracy of switching period is important. Therefore, if the detected switching period has a serious variation under some abnormal conditions, the SR gate should be terminated to prevent fault trigger.

Figure 23. Fault Causal Timing Protection

Gate Expand Limit Protection

Gate expand limit protection controls on-time expansion of the SR MOSFET. Once the discharge time of the internal timing capacitor $(t_{DIS, CT})$ is longer than 115% of previous on time of the SR MOSFET $(t_{on-SR}(n-1));$ $t_{on-SR}(n)$ is limited to 115% of $t_{on-SR}(n-1)$, as shown in [Figure 24.](#page-10-4) When output load changes rapidly from light load to heavy load, voltage-second balance theorem may not be applied. In this transient state, gate expand limit protection is activated to prevent overlap between SR gate and PWM gate.

Figure 24. Gate Expand Limit Protection

RES Voltage Drop Protection

RES voltage drop protection prevents VRES dropping too much within a cycle. The V_{RES} is sampled as a reference voltage, VRES', on VLPC rising edge. Once VRES drops below 90% of V_{RES} ' for longer than a debounce time ($t_{RES-DROP}$), the SR gate is turned off immediately, as shown in [Figure 25.](#page-10-5) When output voltage drops rapidly within a switching cycle, voltage-second balance may not be applied, RES dropping protection is activated to prevent overlap.

Figure 25. V_{RES} Dropping Protection

LPC Pin Open / Short Protection

LPC-Open Protection: If V_{LPC} is higher than V_{LPC-DIS} $(4.2 V)$ for longer than debounce time $t_{LPC-HIGH}$, FAN6204 stops switching immediately and enters Green Mode. V_{LPC} is clamped at 6 V to avoid LPC pin damage.

LPC-Short Protection: If V_{LPC} is pulled to ground and the charging current of timing capacitor (C_T) is near zero, so that SR gate is not output.

RES Pin Open / Short Protection

RES-Open Protection: If VRES is pulled to HIGH level, the gate signal is extremely small and FAN6204 enters Green Mode. In addition, V_{RES} is clamped at 6V to avoid RES pin damage.

RES-Short Protection: If V_{RES} is lower than V_{RES-EN} $(0.7 V)$ for longer than debounce time $t_{RES-LOW}$, FAN6204 stops switching immediately and enters Green Mode.

Under-Voltage Lockout (UVLO)

The power ON and OFF V_{DD} threshold voltages are fixed at 4.8 V and 4.5 V, respectively. With an ultra-low V_{DD} threshold voltage, FAN6204 can be used in various output voltage applications.

V_{DD} Pin Over-Voltage Protection (OVP)

Over-voltage conditions are usually caused by an open feedback loop. V_{DD} over-voltage protection prevents damage on the SR MOSFET. When the voltage on VDD pin exceeds 27.5 V, the SR controller stops switching the SR MOSFET.

Over-Temperature Protection (OTP)

To prevent SR gate from fault triggering in high temperatures, internal over-temperature protection is integrated in FAN6204. Once the temperature is over 140°C, SR gate is disabled until the temperature drops below 120°C.

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